

IRF7317PbF

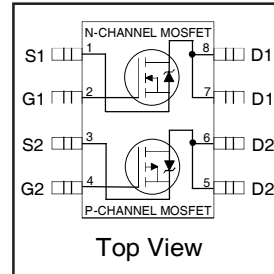
HEXFET® Power MOSFET

- Generation V Technology
- Ultra Low On-Resistance
- Dual N and P Channel MOSFET
- Surface Mount
- Fully Avalanche Rated
- Lead-Free

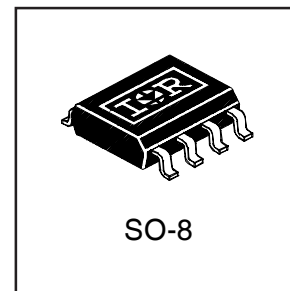
Description

Fifth Generation HEXFETs from International Rectifier utilize advanced processing techniques to achieve extremely low on-resistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET Power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in a wide variety of applications.

The SO-8 has been modified through a customized leadframe for enhanced thermal characteristics and multiple-die capability making it ideal in a variety of power applications. With these improvements, multiple devices can be used in an application with dramatically reduced board space. The package is designed for vapor phase, infra red, or wave soldering techniques.



	N-Ch	P-Ch
V_{DS}	20V	-20V
$R_{DS(on)}$	0.029 Ω	0.058 Ω



Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

		Symbol	Maximum		Units
			N-Channel	P-Channel	
Drain-Source Voltage		V_{DS}	20	-20	A
Gate-Source Voltage		V_{GS}	± 12		
Continuous Drain Current⑤	$T_A = 25^{\circ}\text{C}$		6.6	-5.3	
	$T_A = 70^{\circ}\text{C}$		5.3	-4.3	
Pulsed Drain Current		I_{DM}	26	-21	
Continuous Source Current (Diode Conduction)		I_S	2.5	-2.5	
Maximum Power Dissipation ⑤	$T_A = 25^{\circ}\text{C}$		2.0		W
	$T_A = 70^{\circ}\text{C}$		1.3		
Single Pulse Avalanche Energy		E_{AS}	100	150	mJ
Avalanche Current		I_{AR}	4.1	-2.9	A
Repetitive Avalanche Energy		E_{AR}	0.20		mJ
Peak Diode Recovery dv/dt ②		dv/dt	5.0	-5.0	V/ ns
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to + 150 °C		

Thermal Resistance Ratings

Parameter	Symbol	Limit	Units
Maximum Junction-to-Ambient ⑤	$R_{\theta JA}$	62.5	$^\circ\text{C/W}$

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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter		Min.	Typ.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	N-Ch	20	—	—	V	V _{GS} = 0V, I _D = 250μA
		P-Ch	-20	—	—		V _{GS} = 0V, I _D = -250μA
ΔV _{(BR)DSS} /ΔT _J	Breakdown Voltage Temp. Coefficient	N-Ch	—	0.027	—	V/°C	Reference to 25°C, I _D = 1mA
		P-Ch	—	0.031	—		Reference to 25°C, I _D = -1mA
R _{DS(ON)}	Static Drain-to-Source On-Resistance	N-Ch	—	0.023	0.029	Ω	V _{GS} = 4.5V, I _D = 6.0A ④
			—	0.030	0.046		V _{GS} = 2.7V, I _D = 5.2A ④
		P-Ch	—	0.049	0.058		V _{GS} = -4.5V, I _D = -2.9A ④
			—	0.082	0.098		V _{GS} = -2.7V, I _D = -1.5A ④
V _{GS(th)}	Gate Threshold Voltage	N-Ch	0.7	—	—	V	V _{DS} = V _{GS} , I _D = 250μA
		P-Ch	-0.7	—	—		V _{DS} = V _{GS} , I _D = -250μA
g _{fs}	Forward Transconductance	N-Ch	—	20	—	S	V _{DS} = 10V, I _D = 6.0A ④
		P-Ch	—	5.9	—		V _{DS} = -10V, I _D = -1.5A ④
I _{DSS}	Drain-to-Source Leakage Current	N-Ch	—	—	1.0	μA	V _{DS} = 16V, V _{GS} = 0V
		P-Ch	—	—	-1.0		V _{DS} = -16V, V _{GS} = 0V
		N-Ch	—	—	5.0		V _{DS} = 16V, V _{GS} = 0V, T _J = 55°C
		P-Ch	—	—	-25		V _{DS} = -16V, V _{GS} = 0V, T _J = 55°C
I _{GSS}	Gate-to-Source Forward Leakage	N-P	—	—	±100	nA	V _{GS} = ±12V
Q _g	Total Gate Charge	N-Ch	—	18	27	nC	N-Channel I _D = 6.0A, V _{DS} = 10V, V _{GS} = 4.5V ④
		P-Ch	—	19	29		
Q _{gs}	Gate-to-Source Charge	N-Ch	—	2.2	3.3		P-Channel I _D = -2.9A, V _{DS} = -16V, V _{GS} = -4.5V
		P-Ch	—	4.0	6.1		
Q _{gd}	Gate-to-Drain ("Miller") Charge	N-Ch	—	6.2	9.3		
		P-Ch	—	7.7	12		
t _{d(on)}	Turn-On Delay Time	N-Ch	—	8.1	12	ns	N-Channel V _{DD} = 10V, I _D = 1.0A, R _G = 6.0Ω, R _D = 10Ω ④
		P-Ch	—	15	22		
t _r	Rise Time	N-Ch	—	17	25		
		P-Ch	—	40	60		
t _{d(off)}	Turn-Off Delay Time	N-Ch	—	38	57		P-Channel V _{DD} = -10V, I _D = -2.9A, R _G = 6.0Ω, R _D = 3.4Ω ④
		P-Ch	—	42	63		
t _f	Fall Time	N-Ch	—	31	47		
		P-Ch	—	49	73		
C _{iss}	Input Capacitance	N-Ch	—	900	—	pF	N-Channel V _{GS} = 0V, V _{DS} = 15V, f = 1.0MHz
		P-Ch	—	780	—		
C _{oss}	Output Capacitance	N-Ch	—	430	—		
		P-Ch	—	470	—		P-Channel V _{GS} = 0V, V _{DS} = -15V, f = 1.0MHz
C _{rss}	Reverse Transfer Capacitance	N-Ch	—	200	—		
		P-Ch	—	240	—		

Source-Drain Ratings and Characteristics

	Parameter		Min.	Typ.	Max.	Units	Conditions
I _S	Continuous Source Current (Body Diode)	N-Ch	—	—	2.5	A	
		P-Ch	—	—	-2.5		
I _{SM}	Pulsed Source Current (Body Diode) ①	N-Ch	—	—	26		
		P-Ch	—	—	-21		
V _{SD}	Diode Forward Voltage	N-Ch	—	0.72	1.0	V	T _J = 25°C, I _S = 1.7A, V _{GS} = 0V ③
		P-Ch	—	-0.78	-1.0		T _J = 25°C, I _S = -2.9A, V _{GS} = 0V ③
t _{rr}	Reverse Recovery Time	N-Ch	—	52	77	ns	N-Channel T _J = 25°C, I _F = 1.7A, di/dt = 100A/μs ④
		P-Ch	—	47	71		
Q _{rr}	Reverse Recovery Charge	N-Ch	—	58	86	nC	
		P-Ch	—	49	73		

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 22)
- ② N-Channel I_{SD} ≤ 4.1A, di/dt ≤ 92A/μs, V_{DD} ≤ V_{(BR)DSS}, T_J ≤ 150°C
P-Channel I_{SD} ≤ -2.9A, di/dt ≤ -77A/μs, V_{DD} ≤ V_{(BR)DSS}, T_J ≤ 150°C
- ③ N-Channel Starting T_J = 25°C, L = 12mH R_G = 25Ω, I_{AS} = 4.1A. (See Figure 12)
P-Channel Starting T_J = 25°C, L = 35mH R_G = 25Ω, I_{AS} = -2.9A.
- ④ Pulse width ≤ 300μs; duty cycle ≤ 2%.
- ⑤ Surface mounted on FR-4 board, t ≤ 10sec.

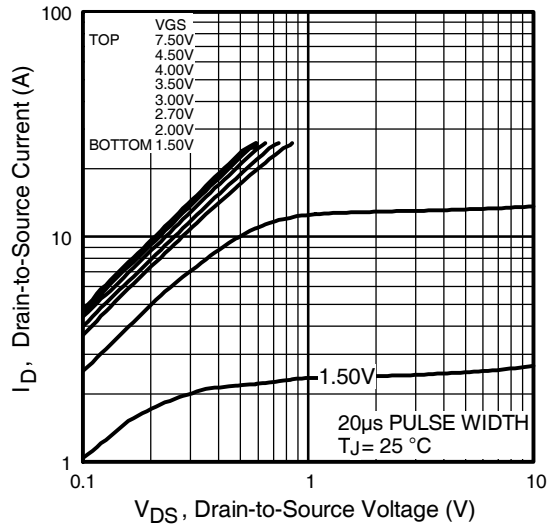


Fig 1. Typical Output Characteristics

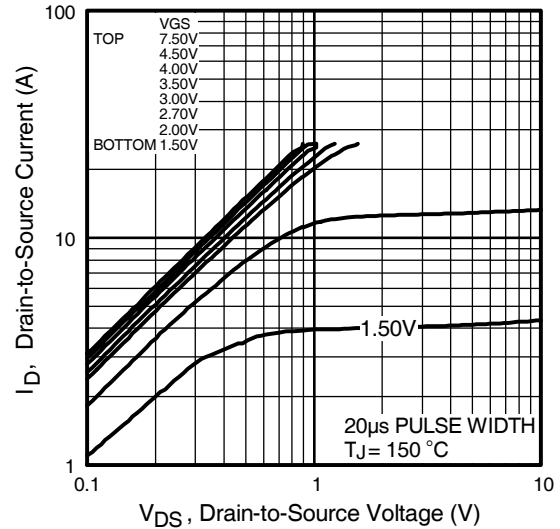


Fig 2. Typical Output Characteristics

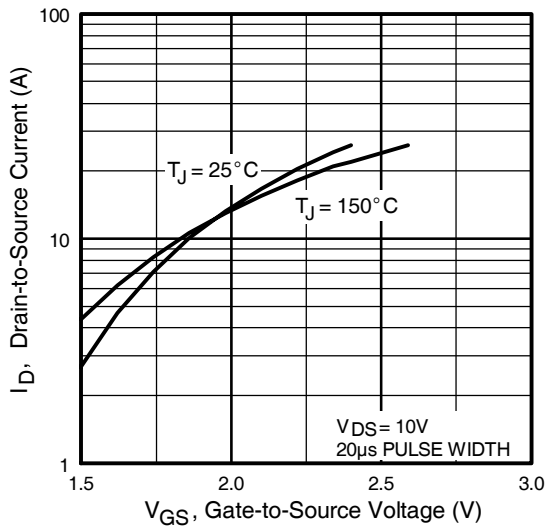


Fig 3. Typical Transfer Characteristics

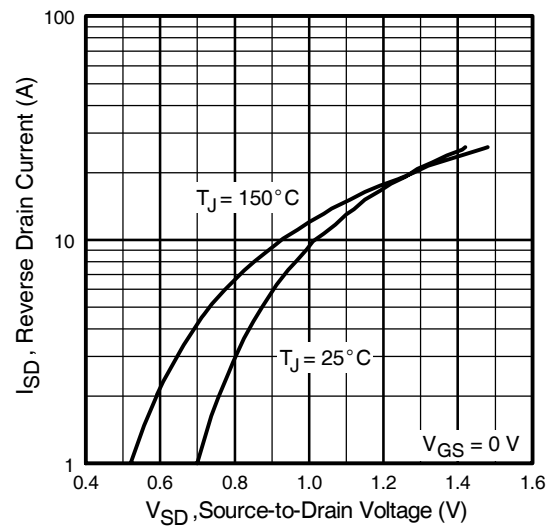


Fig 4. Typical Source-Drain Diode Forward Voltage

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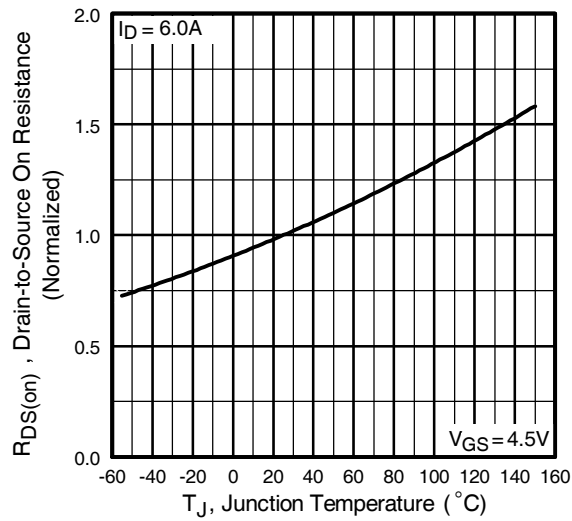


Fig 5. Normalized On-Resistance Vs. Temperature

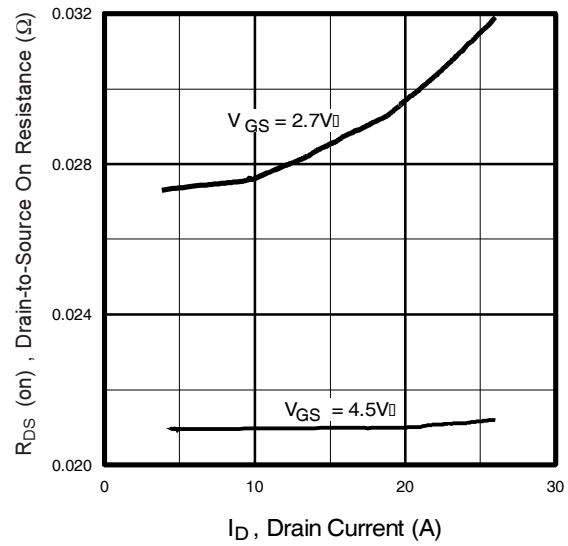


Fig 6. Typical On-Resistance Vs. Drain Current

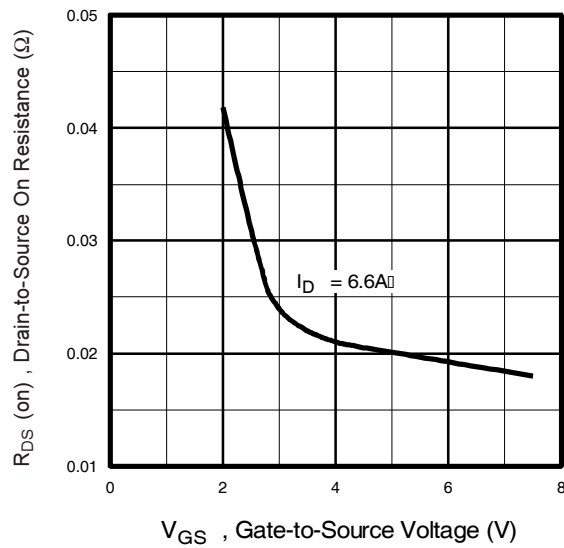


Fig 7. Typical On-Resistance Vs. Gate Voltage

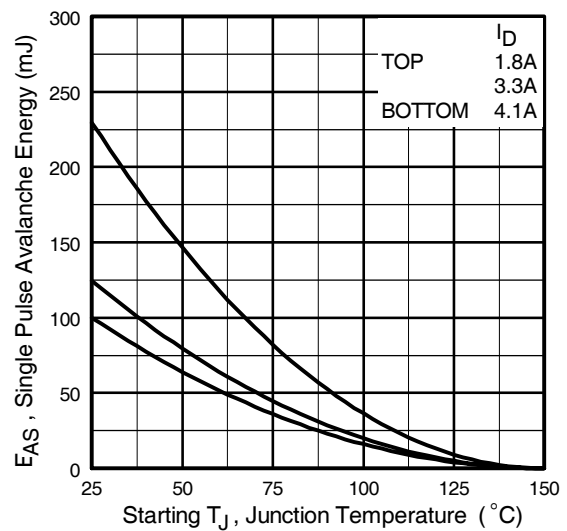


Fig 8. Maximum Avalanche Energy Vs. Drain Current

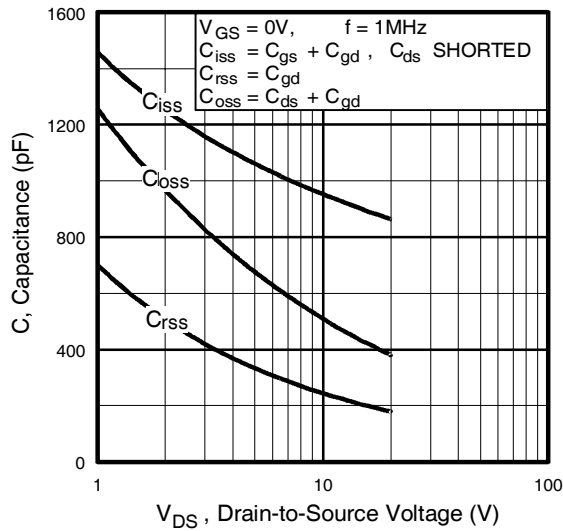


Fig 9. Typical Capacitance Vs. Drain-to-Source Voltage

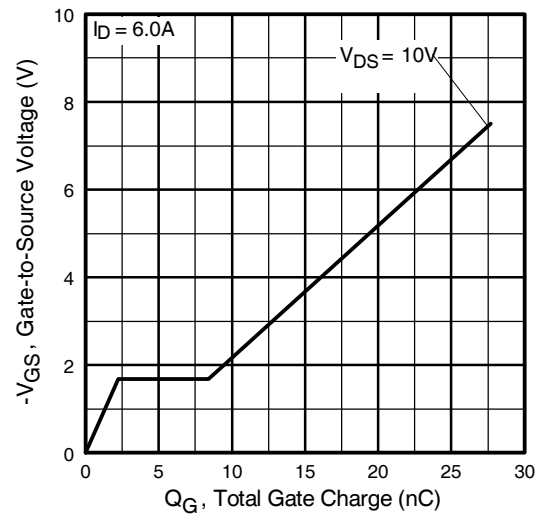


Fig 10. Typical Gate Charge Vs. Gate-to-Source Voltage

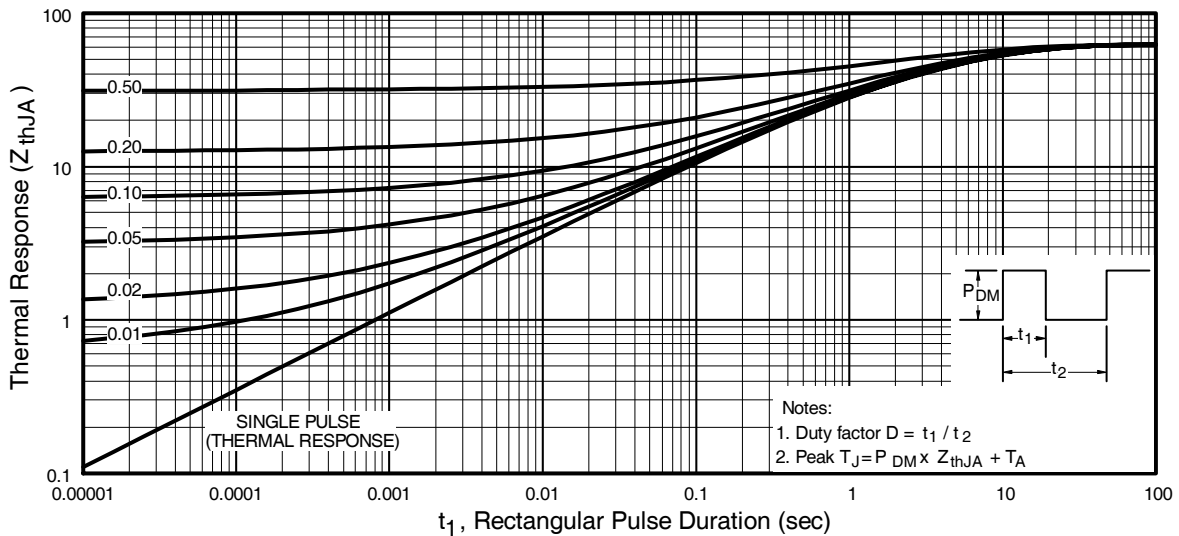


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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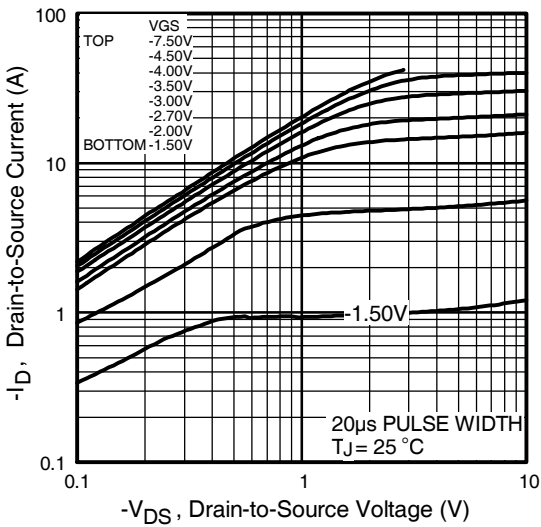


Fig 12. Typical Output Characteristics

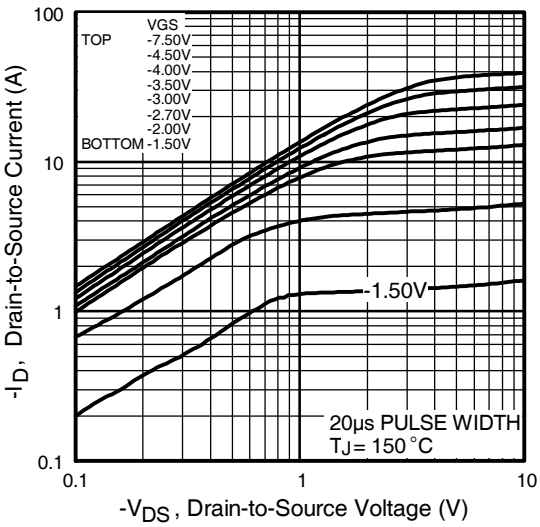


Fig 13. Typical Output Characteristics

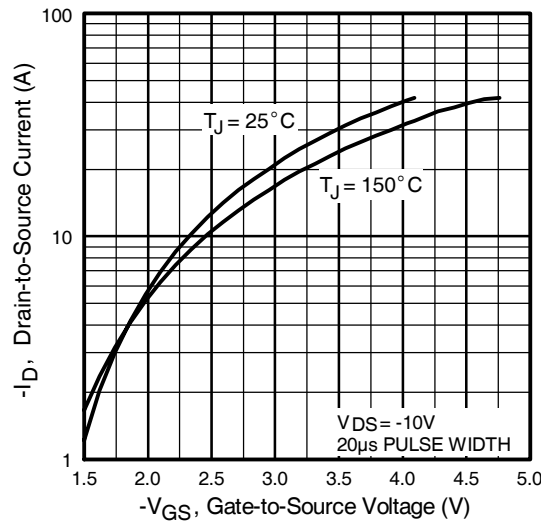


Fig 14. Typical Transfer Characteristics

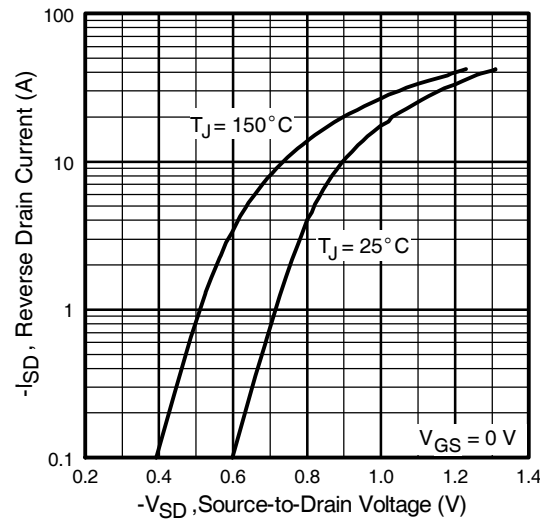
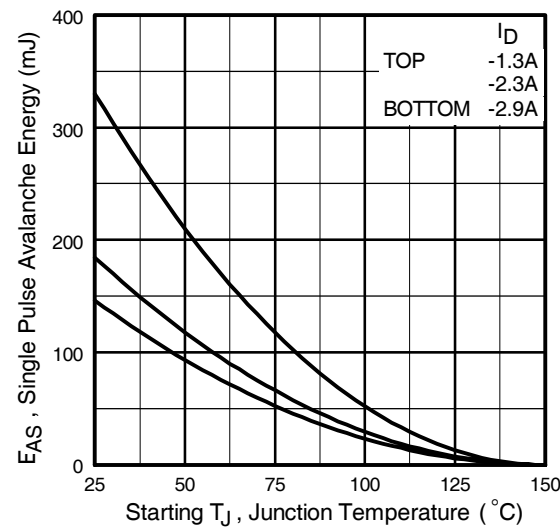
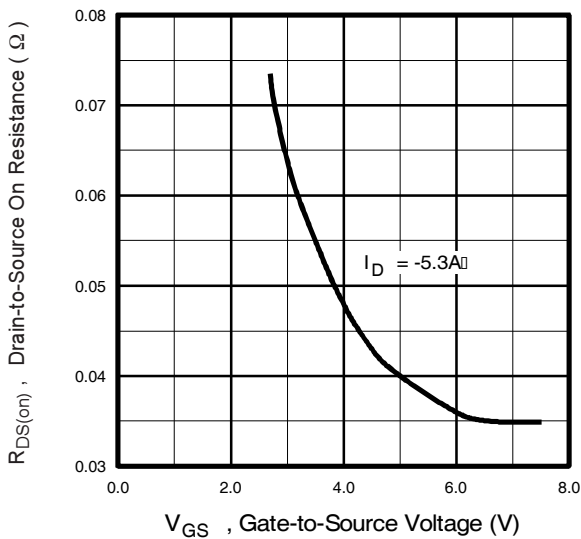
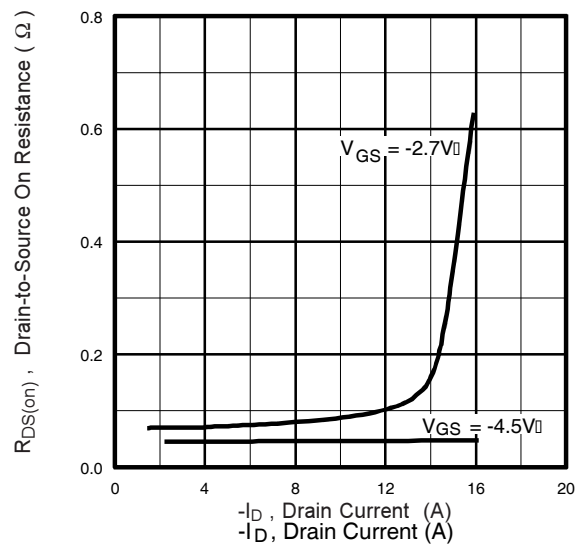
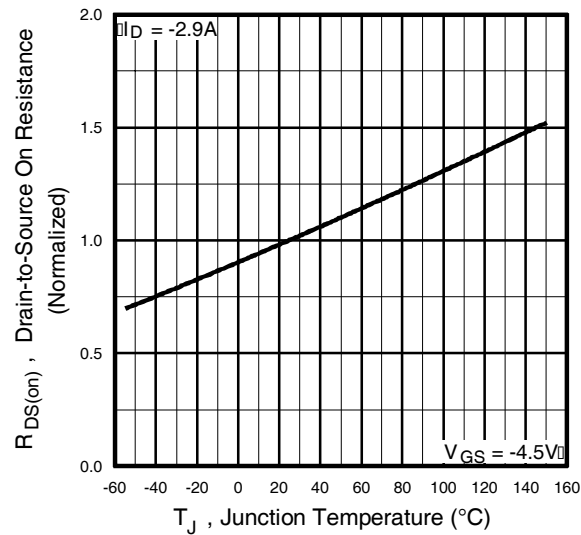


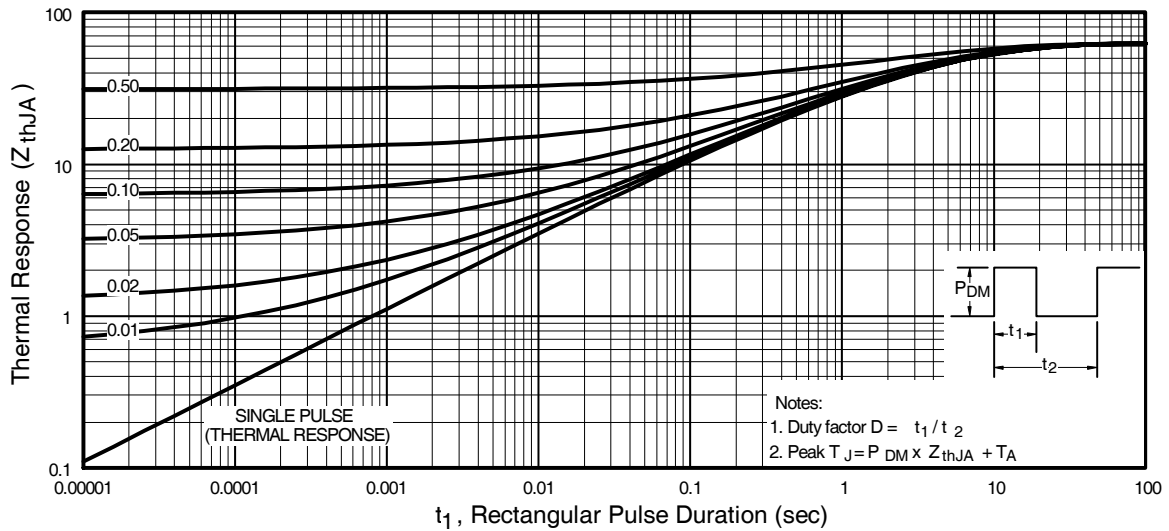
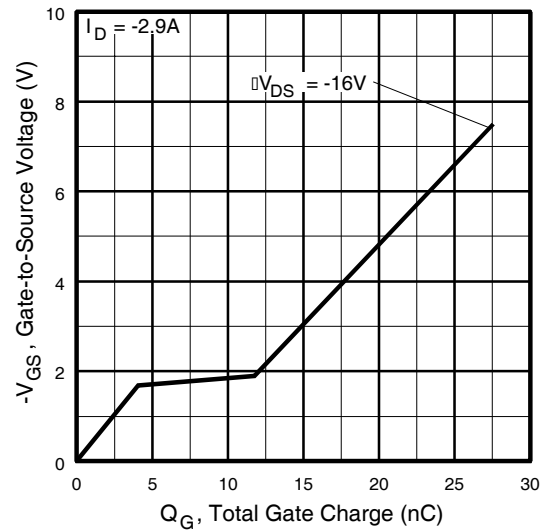
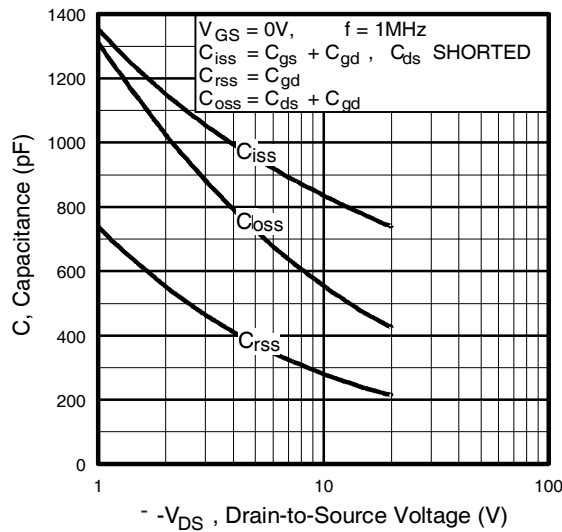
Fig 15. Typical Source-Drain Diode
Forward Voltage



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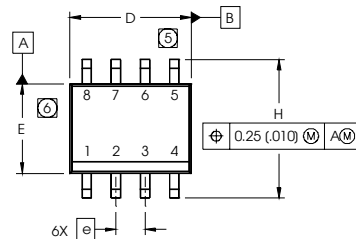
P-Channel

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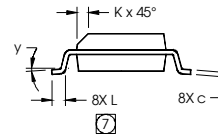
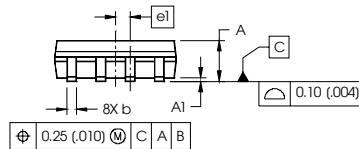


SO-8 Package Outline

Dimensions are shown in millimeters (inches)



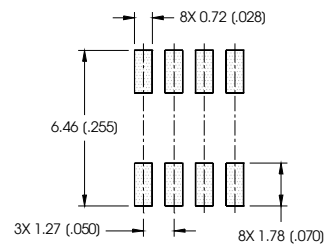
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
AI	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050	BASIC	1.27	BASIC
e1	.025	BASIC	0.635	BASIC
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°



NOTES:

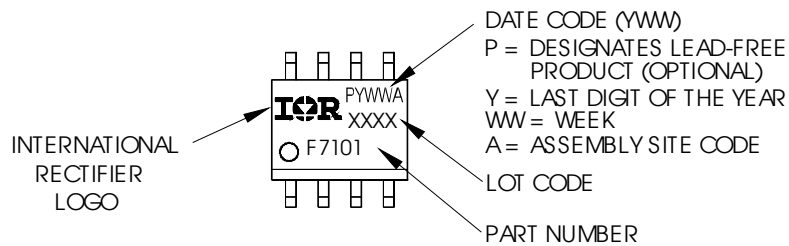
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
6. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
7. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

FOOTPRINT



SO-8 Part Marking Information (Lead-Free)

EXAMPLE: THIS IS AN IRF7101 (MOSFET)

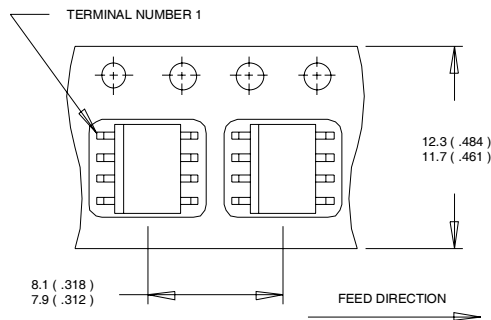


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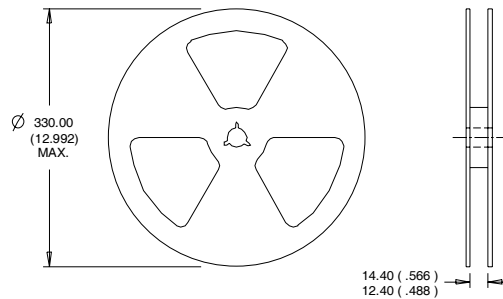
SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

1. CONTROLLING DIMENSION : MILLIMETER.
2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Data and specifications subject to change without notice.
This product has been designed and qualified for the Consumer market.
Qualification Standards can be found on IR's Web site.

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